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## **SPECIFICATION**

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL31B102KDCNNNC
- Description : CAP, 1nF, 200V, ±10%, X7R, 1206

A. Samsung Part Number

			<u>CL</u>	<u>31</u>	<u>B</u>	<u>102</u>	<u>K</u>	<u>D</u>	<u>C</u>	<u>N</u>	<u>N</u>	<u>N</u>	<u>C</u>						
			1	2	3	4	5	6	1	8	9	10	1						
1	Series	Samsung	a Multi-	laver	Cera	amic C	apa	citor											٦
2	Size		inch c	•			•	± 0.1	5	mm		W:	1.6	± 0.	15	mm			
	Dielectric	VZD								-4	1		NI;						
3	Dielectric	X7R					(8)	Inne	r eie	ctroc	ie		Ni						
4	Capacitance	<b>1</b> r	۱F					Tern	ninat	tion			Cu						
5	Capacitance	±10 %	6					Plati	ng				Sn 10	00%		(Pb F	ree)		
	tolerance						9	Proc	luct				Norm	al					
6	Rated Voltage	200 \	/				10	Spee	cial				Rese	rved f	for f	uture	use		
$\bigcirc$	Thickness	0.85 ±	± 0.15	mm			1	Pack	kagir	ng			Card	board	Тур	be, 7"	reel(4,	000ea	)

## B. Samsung Reliability Test and Judgement condition

	Performance	Test condition						
Capacitance	Within specified tolerance	1kHz±10% 1.0±0.2Vrms						
Tan δ (DF)	0.025 max.							
Insulation	More than 500Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.						
Resistance								
Appearance	No abnormal exterior appearance	Visual inspection						
Withstanding	No dielectric breakdown or	200% of the rated voltage						
Voltage	mechanical breakdown							
Temperature	X7R							
Characteristics	(From -55℃ to 125℃, Capacitance change should be within ±15%)							
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.						
of Termination	terminal electrode							
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)						
		with 1.0mm/sec.						
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder						
	is to be soldered newly	245±5℃, 3±0.3sec.						
		(preheating : 80~120 ℃ for 10~30sec.)						
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5°C, 10±1sec.						
Soldering heat	Tan δ, IR : initial spec.							

	Performance	Test condition					
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm					
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)					
		2hours $\times$ 3 direction (x, y, z)					
Moisture	Capacitance change : within ±12.5%	With rated voltage					
Resistance	Tan δ: 0.05 max	40±2℃, 90~95%RH, 500 +12/-0 hour					
	IR ∶ More than 25№ μF						
High Temperature	Capacitance change : within ±12.5%	With 200% of the rated voltage					
Resistance	Tan δ: 0.05 max	Max. operating temperature					
	IR ∶ More than 50MΩ· <i>μ</i> F						
		1000+48/-0 hour					
Temperature	Capacitance change : within ±7.5%	1 cycle condition					
Cycling	Tan δ, IR : initial spec.	Min. operating temperature $\rightarrow$ 25 °C					
		$\rightarrow$ Max. operating temperature $\rightarrow$ 25 °C					
		5 cycles test					

## C. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260+0/-5°C, 10sec. Max )

\* For the more detail Specification, Please refer to the Samsung MLCC catalogue.